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2SB0950 (2SB950), 2SB0950A (2SB950A)

Silicon PNP epitaxial planar type darlington

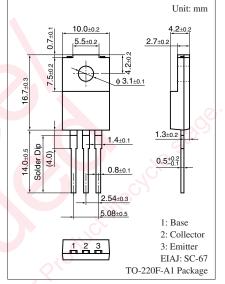
For power amplification and switching

Complementary to 2SD1276 and 2SD1276A

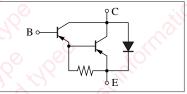
Features

- \bullet High forward current transfer ratio h_{FE}
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings $T_C = 25^{\circ}C$ Symbol Parameter Rating Unit v 2SB0950 V_{CBO} -60 Collector-base voltage (Emitter open) 2SB0950A -80Collector-emitter voltage 2SB0950 V_{CEO} -60V (Base open) 2SB0950A -80Emitter-base voltage (Collector open) V VEBO -5 Collector current I_C -4 A Peak collector current I_{CP} -8 А Collector power P_{C} 40 W $T_a = 25^{\circ}C$ 2 dissipation Junction temperature Ti 150 °C Storage temperature -55 to +150 °C T_{stg}



Internal Connection



Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB0950	V _{CEO}	$I_{\rm C} = -30 \text{ mA}, I_{\rm B} = 0$	-60	1.0		V
(Base open)	2SB0950A			-80	x S		
Base-emitter voltage		V _{BE}	$V_{CE} = -3 V, I_C = -3 A$	Š,		-2.5	V
Collector-base cutoff	2SB0950	I _{CBO}	$V_{CB} = -60 \text{ V}, I_E = 0$			-200	μΑ
current (Emitter open)	2SB0950A		$V_{CB} = -80 \text{ V}, I_E = 0$	0		-200	
Collector-emitter cutoff	2SB0950	I _{CEO}	$V_{CE} = -30 \text{ V}, I_B = 0$			-500	μΑ
current (Base open)	2SB0950A		$V_{CE} = -40 \text{ V}, I_B = 0$			-500	
Emitter-base cutoff current (Collector open)		I_{EBO}	$V_{EB} = -5 V, I_C = 0$			-2	mA
Forward current transfer ratio		h _{FE1}	$V_{CE} = -3 V, I_C = -0.5 A$	1 0 0 0			—
AN AN		h _{FE2} *	$V_{CE} = -3 V, I_C = -3 A$	1 0 0 0		10000	
Collector-emitter saturation voltage		V _{CE(sat)1}	$I_{\rm C} = -3$ A, $I_{\rm B} = -12$ mA			-2	V
All		V _{CE(sat)2}	$I_{C} = -5 \text{ A}, I_{B} = -20 \text{ mA}$			-4	V
Transition frequency		f _T	$V_{CE} = -10 \text{ V}, \text{ I}_{C} = -0.5 \text{ A}, \text{ f} = 1 \text{ MHz}$		20		MHz
Turn-on time		t _{on}	$I_{C} = -3 \text{ A}, I_{B1} = -12 \text{ mA}, I_{B2} = 12 \text{ mA}$		0.3		μs
Storage time		t _{stg}	$V_{CC} = -50 \text{ V}$		2		μs
Fall time		t _f			0.5		μs

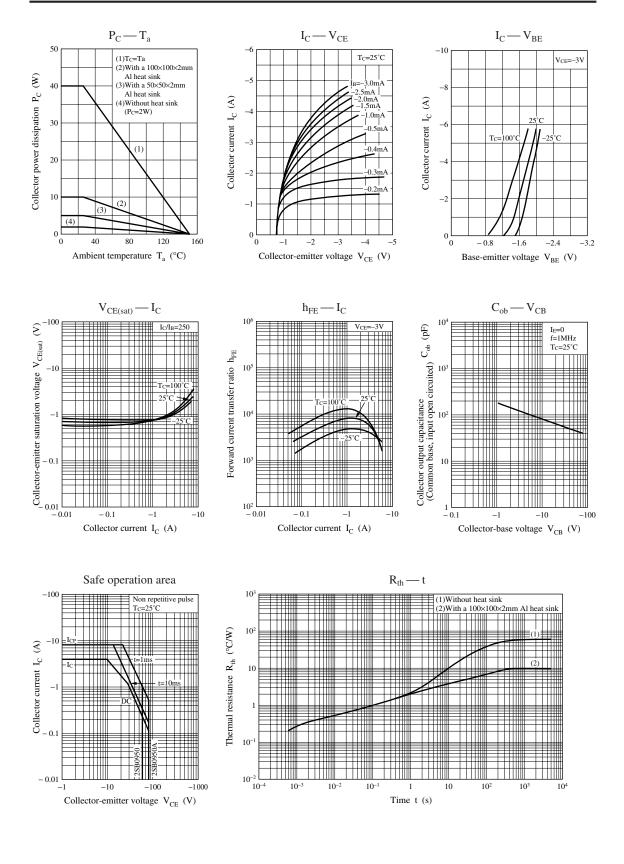
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Rank classification

Rank	R	Q	Р
h _{FE2}	1000 to 2500	2000 to 5000	4000 to 10000

Note) The part numbers in the parenthesis show conventional part number.

2SB0950, 2SB0950A

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